

Bias Resistor Transistor

NPN Silicon Surface Mount Transistor with Monolithic Bias Resistor Network

LDTC114TWT1G

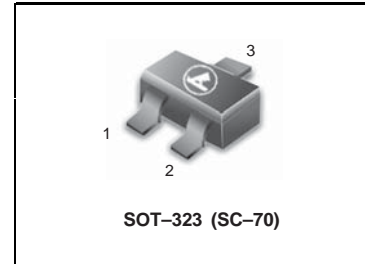
● **Applications**

Inverter, Interface, Driver

● **Features**

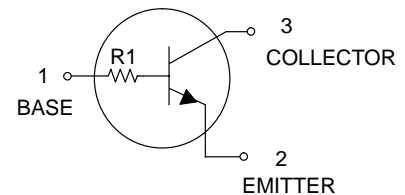
- 1) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see equivalent circuit).
- 2) The bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input. They also have the advantage of almost completely eliminating parasitic effects.
- 3) Only the on/off conditions need to be set for operation, making the device design easy.

- We declare that the material of product compliance with RoHS requirements.



● **Absolute maximum ratings** (Ta=25°C)

| Parameter | Symbol | Limits | Unit |
|-----------------------------|------------------|-------------|------|
| Collector-base voltage | V _{CB0} | 50 | V |
| Collector-emitter voltage | V _{CE0} | 50 | V |
| Emitter-base voltage | V _{EB0} | 5 | V |
| Collector current | I _C | 100 | mA |
| Collector power dissipation | P _C | 200 | mW |
| Junction temperature | T _j | 150 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |



DEVICE MARKING AND RESISTOR VALUES

| Device | Marking | R1 (K) | R2 (K) | Shipping |
|--------------|---------|--------|--------|-------------------|
| LDTC114TWT1G | 8E | 10 | - | 3000/Tape & Reel |
| LDTC114TWT3G | 8E | 10 | - | 10000/Tape & Reel |

● **Electrical characteristics** (Ta=25°C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|--------------------------------------|----------------------|------|------|------|------|--|
| Collector-base breakdown voltage | BV _{CB0} | 50 | - | - | V | I _C =50μA |
| Collector-emitter breakdown voltage | BV _{CE0} | 50 | - | - | V | I _C =1mA |
| Emitter-base breakdown voltage | BV _{EB0} | 5 | - | - | V | I _E =50μA |
| Collector cutoff current | I _{CB0} | - | - | 0.5 | μA | V _{CB} =50V |
| Emitter cutoff current | I _{EB0} | - | - | 0.5 | μA | V _{EB} =4V |
| Collector-emitter saturation voltage | V _{CE(sat)} | - | - | 0.3 | V | I _C /I _B =10mA/1mA |
| DC current transfer ratio | h _{FE} | 100 | 250 | 600 | - | V _{CE} =5V, I _C =1mA |
| Input resistance | R ₁ | 7 | 10 | 13 | kΩ | - |
| Transition frequency | f _T * | - | 250 | - | MHz | V _{CE} =10V, I _E =-5mA, f=100MHz |

* Characteristics of built-in transistor

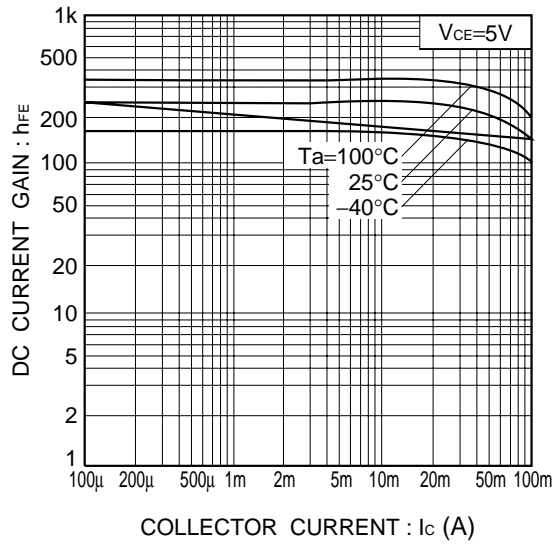
LDT C114TWT1G
●Electrical characteristic curves


Fig.1 DC current gain vs. collector current

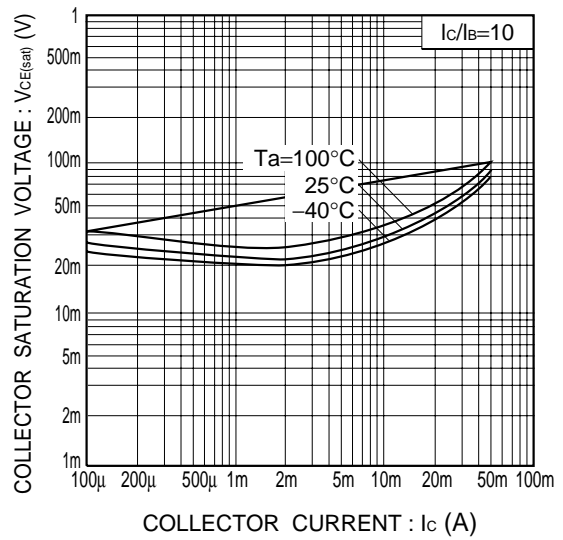
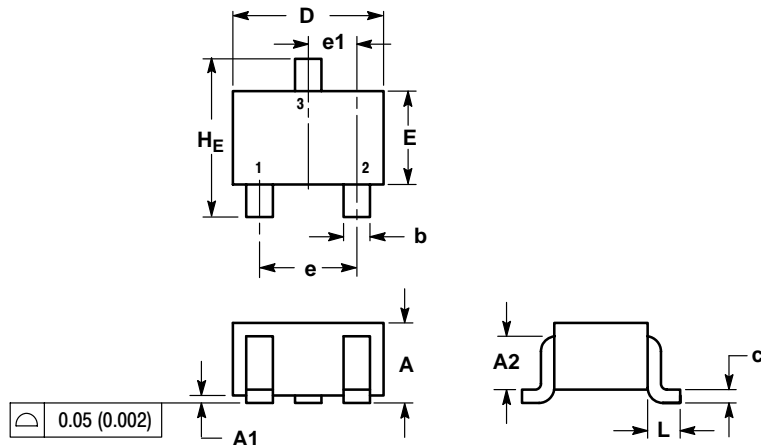


Fig.2 Collector-emitter saturation voltage vs. collector current

LDTC114TWT1G

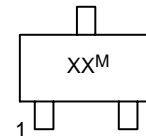
SC-70 (SOT-323)



NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

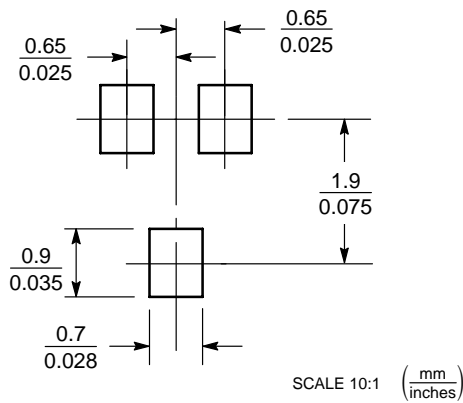
| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|-----------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.80 | 0.90 | 1.00 | 0.032 | 0.035 | 0.040 |
| A1 | 0.00 | 0.05 | 0.10 | 0.000 | 0.002 | 0.004 |
| A2 | 0.7 REF | | | 0.028 REF | | |
| b | 0.30 | 0.35 | 0.40 | 0.012 | 0.014 | 0.016 |
| c | 0.10 | 0.18 | 0.25 | 0.004 | 0.007 | 0.010 |
| D | 1.80 | 2.10 | 2.20 | 0.071 | 0.083 | 0.087 |
| E | 1.15 | 1.24 | 1.35 | 0.045 | 0.049 | 0.053 |
| e | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e1 | 0.65 BSC | | | 0.026 BSC | | |
| L | 0.425 REF | | | 0.017 REF | | |
| HE | 2.00 | 2.10 | 2.40 | 0.079 | 0.083 | 0.095 |

GENERIC MARKING DIAGRAM



XX = Specific Device Code
 M = Date Code
 ■ = Pb-Free Package

SOLDERING FOOTPRINT*



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present.